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Details

Product Status	Active
Core Processor	dsPIC
Core Size	16-Bit
Speed	40 MIPS
Connectivity	I ² C, IrDA, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, Motor Control PWM, POR, PWM, QEI, WDT
Number of I/O	21
Program Memory Size	64KB (64K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 3.6V
Data Converters	A/D 6x10b/12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SOIC (0.295", 7.50mm Width)
Supplier Device Package	28-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/dspic33fj64mc202-e-so

TABLE 4-18: ADC1 REGISTER MAP FOR dsPIC33FJ64MC204/804, dsPIC33FJ128MC204/804 AND dsPIC33FJ32MC304

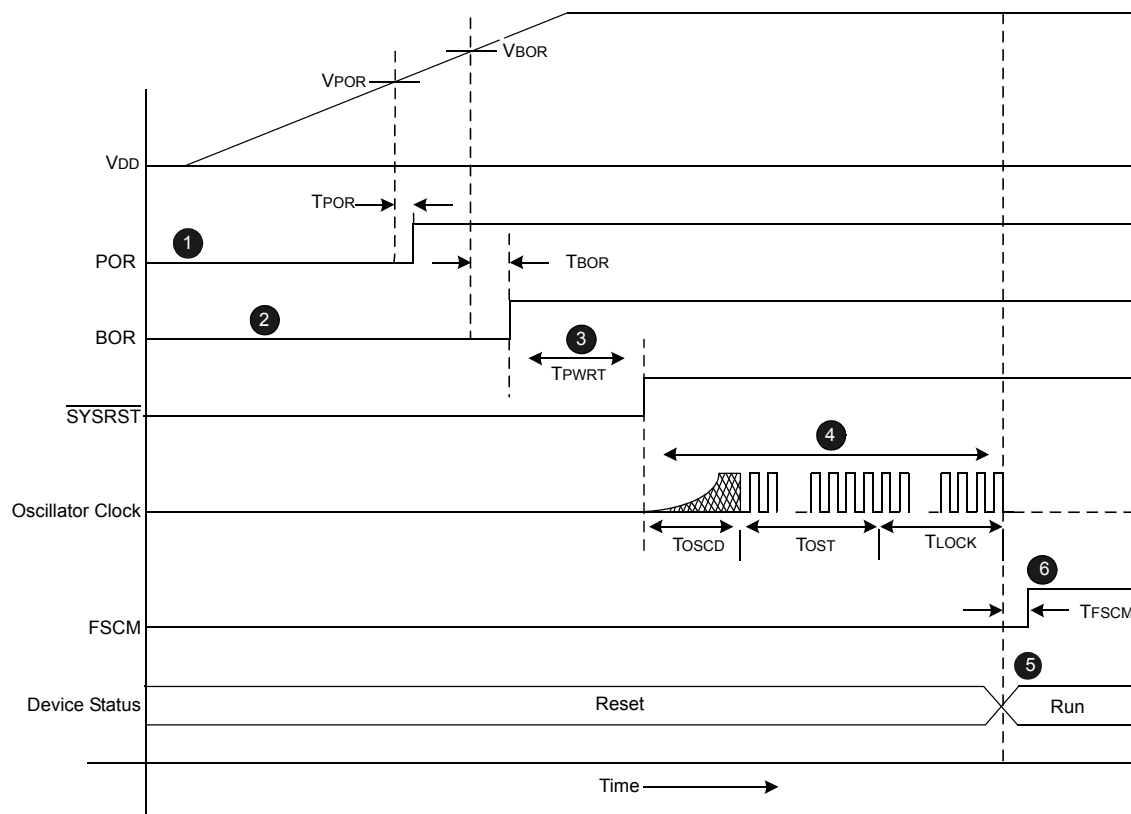
File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets	
ADC1BUF0	0300	ADC Data Buffer 0																	xxxx
AD1CON1	0320	ADON	—	ADSIDL	ADDMABM	—	AD12B	FORM<1:0>		SSRC<2:0>			—	SIMSAM	ASAM	SAMP	DONE	0000	
AD1CON2	0322	VCFG<2:0>			—	—	CSCNA	CHPS<1:0>		BUFS	—	SMPI<3:0>				BUFM	ALTS	0000	
AD1CON3	0324	ADRC	—	—	SAMC<4:0>					ADCS<7:0>									0000
AD1CHS123	0326	—	—	—	—	—	CH123NB<1:0>		CH123SB	—	—	—	—	—	CH123NA<1:0>		CH123SA	0000	
AD1CHS0	0328	CH0NB	—	—	CH0SB<4:0>					CH0NA	—	—	CH0SA<4:0>						0000
AD1PCFGL	032C	—	—	—	—	—	—	—	PCFG8	PCFG7	PCFG6	PCFG5	PCFG4	PCFG3	PCFG2	PCFG1	PCFG0	0000	
AD1CSSL	0330	—	—	—	—	—	—	—	CSS8	CSS7	CSS6	CSS5	CSS4	CSS3	CSS2	CSS1	CSS0	0000	
AD1CON4	0332	—	—	—	—	—	—	—	—	—	—	—	—	—	DMABL<2:0>			0000	

Legend: x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

TABLE 4-19: DAC1 REGISTER MAP FOR dsPIC33FJ128MC804 AND dsPIC33FJ64MC804

SFR Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
DAC1CON	03F0	DACEN	—	DACSIDL	AMPON	—	—	—	FORM	—	DACFDIV<6:0>							0000
DAC1STAT	03F2	LOEN	—	LMVOEN	—	—	LITYPE	LFULL	LEMPY	ROEN	—	RMVOEN	—	—	RITYPE	RFULL	REMPY	0000
DAC1DFLT	03F4	DAC1DFLT<15:0>																0000
DAC1RDAT	03F6	DAC1RDAT<15:0>																0000
DAC1LDAT	03F8	DAC1LDAT<15:0>																0000

Legend: x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

FIGURE 6-2: SYSTEM RESET TIMING

- Note 1:** **POR:** A POR circuit holds the device in Reset when the power supply is turned on. The POR circuit is active until VDD crosses the V_{POR} threshold and the delay T_{POR} has elapsed.
- 2:** **BOR:** The on-chip voltage regulator has a BOR circuit that keeps the device in Reset until VDD crosses the V_{BOR} threshold and the delay T_{BOR} has elapsed. The delay T_{BOR} ensures the voltage regulator output becomes stable.
- 3:** **PWRT Timer:** The programmable power-up timer continues to hold the processor in Reset for a specific period of time (T_{PWRT}) after a BOR. The delay T_{PWRT} ensures that the system power supplies have stabilized at the appropriate level for full-speed operation. After the delay T_{PWRT} has elapsed, the $SYSRST$ becomes inactive, which in turn enables the selected oscillator to start generating clock cycles.
- 4:** **Oscillator Delay:** The total delay for the clock to be ready for various clock source selections are given in Table 6-1. Refer to Section 9.0 "Oscillator Configuration" for more information.
- 5:** When the oscillator clock is ready, the processor begins execution from location 0x000000. The user application programs a `GOTO` instruction at the reset address, which redirects program execution to the appropriate start-up routine.
- 6:** The Fail-Safe Clock Monitor (FSCM), if enabled, begins to monitor the system clock when the system clock is ready and the delay T_{FSCM} has elapsed.

REGISTER 7-4: INTCON2: INTERRUPT CONTROL REGISTER 2

R/W-0	R-0	U-0	U-0	U-0	U-0	U-0	U-0
ALTIVT	DISI	—	—	—	—	—	—
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0
—	—	—	—	—	INT2EP	INT1EP	INT0EP
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 15 **ALTIVT:** Enable Alternate Interrupt Vector Table bit

1 = Use alternate vector table

0 = Use standard (default) vector table

bit 14 **DISI:** DISI Instruction Status bit

1 = DISI instruction is active

0 = DISI instruction is not active

bit 13-3 **Unimplemented:** Read as '0'

bit 2 **INT2EP:** External Interrupt 2 Edge Detect Polarity Select bit

1 = Interrupt on negative edge

0 = Interrupt on positive edge

bit 1 **INT1EP:** External Interrupt 1 Edge Detect Polarity Select bit

1 = Interrupt on negative edge

0 = Interrupt on positive edge

bit 0 **INT0EP:** External Interrupt 0 Edge Detect Polarity Select bit

1 = Interrupt on negative edge

0 = Interrupt on positive edge

REGISTER 7-14: IEC4: INTERRUPT ENABLE CONTROL REGISTER 4

R/W-0	R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0	U-0
DAC1LIE ⁽²⁾	DAC1RIE ⁽²⁾	—	—	QE12IE	FLTA2IE	PWM2IE	—
bit 15							bit 8
U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0
—	C1TXIE ⁽¹⁾	DMA7IE	DMA6IE	CRCIE	U2EIE	U1EIE	—
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'
-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

- bit 15 **DAC1LIE:** DAC Left Channel Interrupt Enable bit⁽²⁾
1 = Interrupt request enabled
0 = Interrupt request not enabled
- bit 14 **DAC1RIE:** DAC Right Channel Interrupt Enable bit⁽²⁾
1 = Interrupt request enabled
0 = Interrupt request not enabled
- bit 13-12 **Unimplemented:** Read as '0'
- bit 11 **QE12IE:** QE12 Event Interrupt Flag Status bit
1 = Interrupt request enabled
0 = Interrupt request not enabled
- bit 10 **FLTA2IE:** PWM2 Fault A Interrupt Enable bit
1 = Interrupt request enabled
0 = Interrupt request not enabled
- bit 9 **PWM2IE:** PWM2 Error Interrupt Enable bit
1 = Interrupt request enabled
0 = Interrupt request not enabled
- bit 8-7 **Unimplemented:** Read as '0'
- bit 6 **C1TXIE:** ECAN1 Transmit Data Request Interrupt Enable bit⁽¹⁾
1 = Interrupt request occurred
0 = Interrupt request not occurred
- bit 5 **DMA7IE:** DMA Channel 7 Data Transfer Complete Interrupt Enable bit
1 = Interrupt request enabled
0 = Interrupt request not enabled
- bit 4 **DMA6IE:** DMA Channel 6 Data Transfer Complete Interrupt Enable bit
1 = Interrupt request enabled
0 = Interrupt request not enabled
- bit 3 **CRCIE:** CRC Generator Interrupt Enable bit
1 = Interrupt request enabled
0 = Interrupt request not enabled
- bit 2 **U2EIE:** UART2 Error Interrupt Enable bit
1 = Interrupt request enabled
0 = Interrupt request not enabled
- bit 1 **U1EIE:** UART1 Error Interrupt Enable bit
1 = Interrupt request enabled
0 = Interrupt request not enabled
- bit 0 **Unimplemented:** Read as '0'

Note 1: Interrupts are disabled on devices without an ECAN™ module.

2: Interrupts are disabled on devices without an Audio DAC module.

REGISTER 8-7: DMACS0: DMA CONTROLLER STATUS REGISTER 0 (CONTINUED)

- bit 3 **XWCOL3:** Channel 3 DMA RAM Write Collision Flag bit
 1 = Write collision detected
 0 = No write collision detected
- bit 2 **XWCOL2:** Channel 2 DMA RAM Write Collision Flag bit
 1 = Write collision detected
 0 = No write collision detected
- bit 1 **XWCOL1:** Channel 1 DMA RAM Write Collision Flag bit
 1 = Write collision detected
 0 = No write collision detected
- bit 0 **XWCOL0:** Channel 0 DMA RAM Write Collision Flag bit
 1 = Write collision detected
 0 = No write collision detected

REGISTER 8-9: DSADR: MOST RECENT DMA RAM ADDRESS

R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
DSADR<15:8>							
bit 15							
bit 8							

R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
DSADR<7:0>							
bit 7							
bit 0							

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 15-0 **DSADR<15:0>**: Most Recent DMA RAM Address Accessed by DMA Controller bits

REGISTER 10-2: PMD2: PERIPHERAL MODULE DISABLE CONTROL REGISTER 2

R/W-0	R/W-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0
IC8MD	IC7MD	—	—	—	—	IC2MD	IC1MD
bit 15						bit 8	

U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	—	—	OC4MD	OC3MD	OC2MD	OC1MD
bit 7						bit 0	

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

- bit 15 **IC8MD:** Input Capture 8 Module Disable bit
 1 = Input Capture 8 module is disabled
 0 = Input Capture 8 module is enabled
- bit 14 **IC7MD:** Input Capture 7 Module Disable bit
 1 = Input Capture 7 module is disabled
 0 = Input Capture 7 module is enabled
- bit 13-10 **Unimplemented:** Read as '0'
- bit 9 **IC2MD:** Input Capture 2 Module Disable bit
 1 = Input Capture 2 module is disabled
 0 = Input Capture 2 module is enabled
- bit 8 **IC1MD:** Input Capture 1 Module Disable bit
 1 = Input Capture 1 module is disabled
 0 = Input Capture 1 module is enabled
- bit 7-4 **Unimplemented:** Read as '0'
- bit 3 **OC4MD:** Output Compare 4 Module Disable bit
 1 = Output Compare 4 module is disabled
 0 = Output Compare 4 module is enabled
- bit 2 **OC3MD:** Output Compare 3 Module Disable bit
 1 = Output Compare 3 module is disabled
 0 = Output Compare 3 module is enabled
- bit 1 **OC2MD:** Output Compare 2 Module Disable bit
 1 = Output Compare 2 module is disabled
 0 = Output Compare 2 module is enabled
- bit 0 **OC1MD:** Output Compare 1 Module Disable bit
 1 = Output Compare 1 module is disabled
 0 = Output Compare 1 module is enabled

REGISTER 11-16: RPINR20: PERIPHERAL PIN SELECT INPUT REGISTER 20

U-0	U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	—	SCK1R<4:0>				
bit 15							bit 8

U-0	U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	—	SDI1R<4:0>				
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 15-13 **Unimplemented:** Read as '0'

bit 12-8 **SCK1R<4:0>:** Assign SPI1 Clock Input (SCK1) to the corresponding RPn pin

11111 = Input tied to Vss

11001 = Input tied to RP25

•

•

•

00001 = Input tied to RP1

00000 = Input tied to RP0

bit 7-5 **Unimplemented:** Read as '0'

bit 4-0 **SDI1R<4:0>:** Assign SPI1 Data Input (SDI1) to the corresponding RPn pin

11111 = Input tied to Vss

11001 = Input tied to RP25

•

•

•

00001 = Input tied to RP1

00000 = Input tied to RP0

14.0 INPUT CAPTURE

Note 1: This data sheet summarizes the features of the dsPIC33FJ32MC302/304, dsPIC33FJ64MCX02/X04 and dsPIC33FJ128MCX02/X04 family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **Section 12. "Input Capture"** (DS70198) of the "dsPIC33F/PIC24H Family Reference Manual", which is available from the Microchip web site (www.microchip.com).

2: Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 "Memory Organization"** in this data sheet for device-specific register and bit information.

The Input Capture module is useful in applications that requires frequency (period) and pulse measurement. The dsPIC33FJ32MC302/304, dsPIC33FJ64MCX02/X04 and dsPIC33FJ128MCX02/X04 devices support up to four input capture channels.

The input capture module captures the 16-bit value of the selected Time Base register when an event occurs at the ICx pin. The events that cause a capture event are listed below in three categories:

- Simple Capture Event modes:
 - Capture timer value on every falling edge of input at ICx pin
 - Capture timer value on every rising edge of input at ICx pin
- Capture timer value on every edge (rising and falling)
- Prescaler Capture Event modes:
 - Capture timer value on every 4th rising edge of input at ICx pin
 - Capture timer value on every 16th rising edge of input at ICx pin

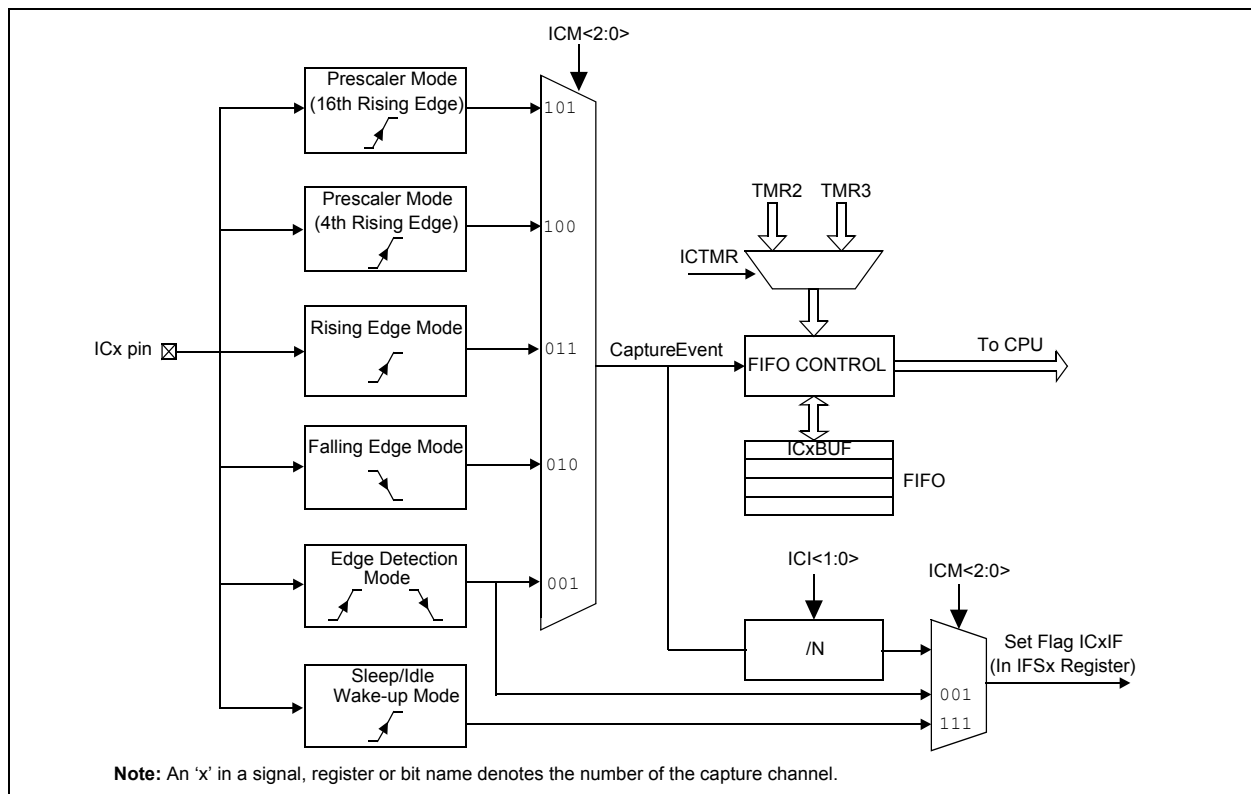
Each input capture channel can select one of two 16-bit timers (Timer2 or Timer3) for the time base. The selected timer can use either an internal or external clock.

Other operational features include:

- Device wake-up from capture pin during CPU Sleep and Idle modes
- Interrupt on input capture event
- 4-word FIFO buffer for capture values
 - Interrupt optionally generated after 1, 2, 3 or 4 buffer locations are filled
- Use of input capture to provide additional sources of external interrupts

Note: Only IC1 and IC2 can trigger a DMA data transfer. If DMA data transfers are required, the FIFO buffer size must be set to '1' (IC1<1:0> = 00)

FIGURE 14-1: INPUT CAPTURE BLOCK DIAGRAM



REGISTER 17-1: QEIxCON: QEIx CONTROL REGISTER (x = 1 or 2) (CONTINUED)

bit 5	TQGATE: Timer Gated Time Accumulation Enable bit 1 = Timer gated time accumulation enabled 0 = Timer gated time accumulation disabled
bit 4-3	TQCKPS<1:0>: Timer Input Clock Prescale Select bits ⁽³⁾ 11 = 1:256 prescale value 10 = 1:64 prescale value 01 = 1:8 prescale value 00 = 1:1 prescale value
bit 2	POSRES: Position Counter Reset Enable bit ⁽⁴⁾ 1 = Index Pulse resets Position Counter 0 = Index Pulse does not reset Position Counter
bit 1	TQCS: Timer Clock Source Select bit 1 = External clock from pin QEAx (on the rising edge) 0 = Internal clock (Tcy)
bit 0	UPDN_SRC: Position Counter Direction Selection Control bit ⁽⁵⁾ 1 = QEBx pin state defines position counter direction 0 = Control/Status bit, UPDN (QEIxCON<11>), defines timer counter (POSxCNT) direction

- Note 1:** This bit only applies when QEIM<2:0> = '110' or '100'.
- 2:** Read-only bit when QEIM<2:0> = '1xx'. Read/write bit when QEIM<2:0> = '001'.
- 3:** Prescaler utilized for 16-bit Timer mode only.
- 4:** This bit applies only when QEIM<2:0> = 100 or 110.
- 5:** When configured for QEI mode, this control bit is a 'don't care'.

REGISTER 18-2: SPIxCON1: SPIx CONTROL REGISTER 1

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	—	DISSCK	DISSDO	MODE16	SMP	CKE ⁽¹⁾
bit 15						bit 8	

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
SSEN ⁽³⁾	CKP	MSTEN	SPRE<2:0> ⁽²⁾			PPRE<1:0> ⁽²⁾	
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 15-13 **Unimplemented:** Read as '0'

bit 12 **DISSCK:** Disable SCKx Pin bit (SPI Master modes only)

1 = Internal SPI clock is disabled, pin functions as I/O

0 = Internal SPI clock is enabled

bit 11 **DISSDO:** Disable SDOx Pin bit

1 = SDOx pin is not used by module; pin functions as I/O

0 = SDOx pin is controlled by the module

bit 10 **MODE16:** Word/Byte Communication Select bit

1 = Communication is word-wide (16 bits)

0 = Communication is byte-wide (8 bits)

bit 9 **SMP:** SPIx Data Input Sample Phase bit

Master mode:

1 = Input data sampled at end of data output time

0 = Input data sampled at middle of data output time

Slave mode:

SMP must be cleared when SPIx is used in Slave mode.

bit 8 **CKE:** SPIx Clock Edge Select bit⁽¹⁾

1 = Serial output data changes on transition from active clock state to Idle clock state (see bit 6)

0 = Serial output data changes on transition from Idle clock state to active clock state (see bit 6)

bit 7 **SSEN:** Slave Select Enable bit (Slave mode)⁽³⁾

1 = \overline{SSx} pin used for Slave mode

0 = \overline{SSx} pin not used by module. Pin controlled by port function

bit 6 **CKP:** Clock Polarity Select bit

1 = Idle state for clock is a high level; active state is a low level

0 = Idle state for clock is a low level; active state is a high level

bit 5 **MSTEN:** Master Mode Enable bit

1 = Master mode

0 = Slave mode

Note 1: This bit is not used in Framed SPI modes. Program this bit to '0' for the Framed SPI modes (FRMEN = 1).

2: Do not set both Primary and Secondary prescalers to a value of 1:1.

3: This bit must be cleared when FRMEN = 1.

REGISTER 19-1: I2CxCON: I2Cx CONTROL REGISTER

R/W-0	U-0	R/W-0	R/W-1, HC	R/W-0	R/W-0	R/W-0	R/W-0
I2CEN	—	I2CSIDL	SCLREL	IPMIEN	A10M	DISSLW	SMEN
bit 15						bit 8	

R/W-0	R/W-0	R/W-0	R/W-0, HC	R/W-0, HC	R/W-0, HC	R/W-0, HC	R/W-0, HC
GCEN	STREN	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN
bit 7						bit 0	

Legend:	U = Unimplemented bit, read as '0'		
R = Readable bit	W = Writable bit	HS = Set in hardware	HC = Cleared in Hardware
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

- bit 15 **I2CEN:** I2Cx Enable bit
1 = Enables the I2Cx module and configures the SDAx and SCLx pins as serial port pins
0 = Disables the I2Cx module. All I²C™ pins are controlled by port functions
- bit 14 **Unimplemented:** Read as '0'
- bit 13 **I2CSIDL:** Stop in Idle Mode bit
1 = Discontinue module operation when device enters an Idle mode
0 = Continue module operation in Idle mode
- bit 12 **SCLREL:** SCLx Release Control bit (when operating as I²C slave)
1 = Release SCLx clock
0 = Hold SCLx clock low (clock stretch)
If STREN = 1:
Bit is R/W (i.e., software can write '0' to initiate stretch and write '1' to release clock). Hardware clear at beginning of slave transmission. Hardware clear at end of slave reception.
If STREN = 0:
Bit is R/S (i.e., software can only write '1' to release clock). Hardware clear at beginning of slave transmission.
- bit 11 **IPMIEN:** Intelligent Peripheral Management Interface (IPMI) Enable bit
1 = IPMI mode is enabled; all addresses Acknowledged
0 = IPMI mode disabled
- bit 10 **A10M:** 10-bit Slave Address bit
1 = I2CxADD is a 10-bit slave address
0 = I2CxADD is a 7-bit slave address
- bit 9 **DISSLW:** Disable Slew Rate Control bit
1 = Slew rate control disabled
0 = Slew rate control enabled
- bit 8 **SMEN:** SMBus Input Levels bit
1 = Enable I/O pin thresholds compliant with SMBus specification
0 = Disable SMBus input thresholds
- bit 7 **GCEN:** General Call Enable bit (when operating as I²C slave)
1 = Enable interrupt when a general call address is received in the I2CxRSR (module is enabled for reception)
0 = General call address disabled
- bit 6 **STREN:** SCLx Clock Stretch Enable bit (when operating as I²C slave)
Used in conjunction with SCLREL bit.
1 = Enable software or receive clock stretching
0 = Disable software or receive clock stretching

REGISTER 21-8: CIEC: ECAN™ TRANSMIT/RECEIVE ERROR COUNT REGISTER

R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
TERRCNT<7:0>							
bit 15				bit 8			

R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
RERRCNT<7:0>							
bit 7				bit 0			

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'
 -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-8 **TERRCNT<7:0>**: Transmit Error Count bits

bit 7-0 **RERRCNT<7:0>**: Receive Error Count bits

REGISTER 21-9: CIECFG1: ECAN™ BAUD RATE CONFIGURATION REGISTER 1

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15				bit 8			

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
SJW<1:0>		BRP<5:0>					
bit 7				bit 0			

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'
 -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-8 **Unimplemented:** Read as '0'

bit 7-6 **SJW<1:0>**: Synchronization Jump Width bits

11 = Length is 4 x T_Q

10 = Length is 3 x T_Q

01 = Length is 2 x T_Q

00 = Length is 1 x T_Q

bit 5-0 **BRP<5:0>**: Baud Rate Prescaler bits

11 1111 = T_Q = 2 x 64 x 1/FCAN

•

•

•

00 0010 = T_Q = 2 x 3 x 1/FCAN

00 0001 = T_Q = 2 x 2 x 1/FCAN

00 0000 = T_Q = 2 x 1 x 1/FCAN

23.4 DAC CLOCK

The DAC clock signal clocks the internal logic of the Audio DAC module. The data sample rate of the Audio DAC is an integer division of the rate of the DAC clock. The DAC clock is generated via a clock divider circuit that accepts an auxiliary clock from the auxiliary oscillator. The divisor ratio is programmed by clock

divider bits (DACFDIV<6:0>) in the DAC Control register (DAC1CON). The resulting DAC clock must not exceed 25.6 MHz. If lower sample rates are to be used, then the DAC filter clock frequency may be reduced to reduce power consumption. The DAC clock frequency is 256 times the sampling frequency.

FIGURE 23-1: BLOCK DIAGRAM OF AUDIO DIGITAL-TO-ANALOG CONVERTER (DAC)

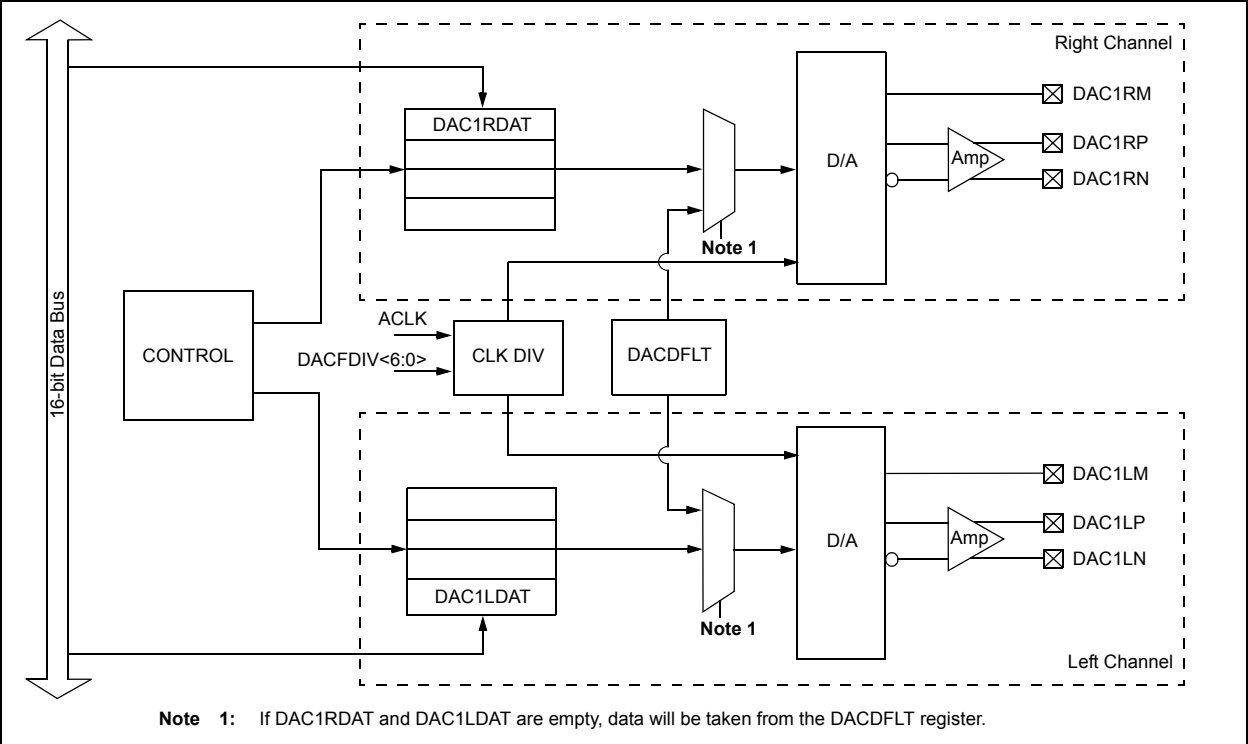
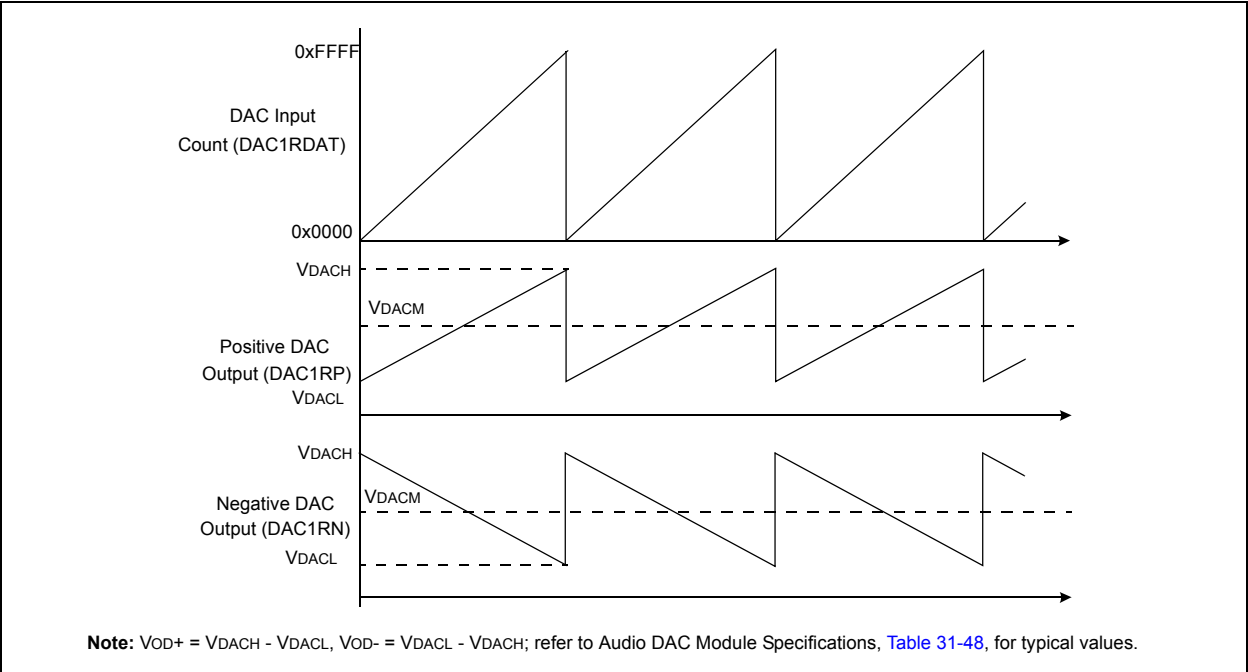


FIGURE 23-2: AUDIO DAC OUTPUT FOR RAMP INPUT (UNSIGNED)



26.0 PROGRAMMABLE CYCLIC REDUNDANCY CHECK (CRC) GENERATOR

Note 1: This data sheet summarizes the features of the dsPIC33FJ32MC302/304, dsPIC33FJ64MCX02/X04 and dsPIC33FJ128MCX02/X04 family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **Section 36. “Programmable Cyclic Redundancy Check (CRC)”** (DS70298) of the “dsPIC33F/PIC24H Family Reference Manual”, which is available from the Microchip web site (www.microchip.com).

2: Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 “Memory Organization”** in this data sheet for device-specific register and bit information.

The programmable CRC generator offers the following features:

- User-programmable polynomial CRC equation
- Interrupt output
- Data FIFO

26.1 Overview

The module implements a software configurable CRC generator. The terms of the polynomial and its length can be programmed using the CRCXOR bits ($X<15:1>$) and the CRCCON bits ($PLEN<3:0>$), respectively.

EQUATION 26-1: CRC EQUATION

$$x^{16} + x^{12} + x^5 + 1$$

To program this polynomial into the CRC generator, the CRC register bits should be set as shown in [Table 26-1](#).

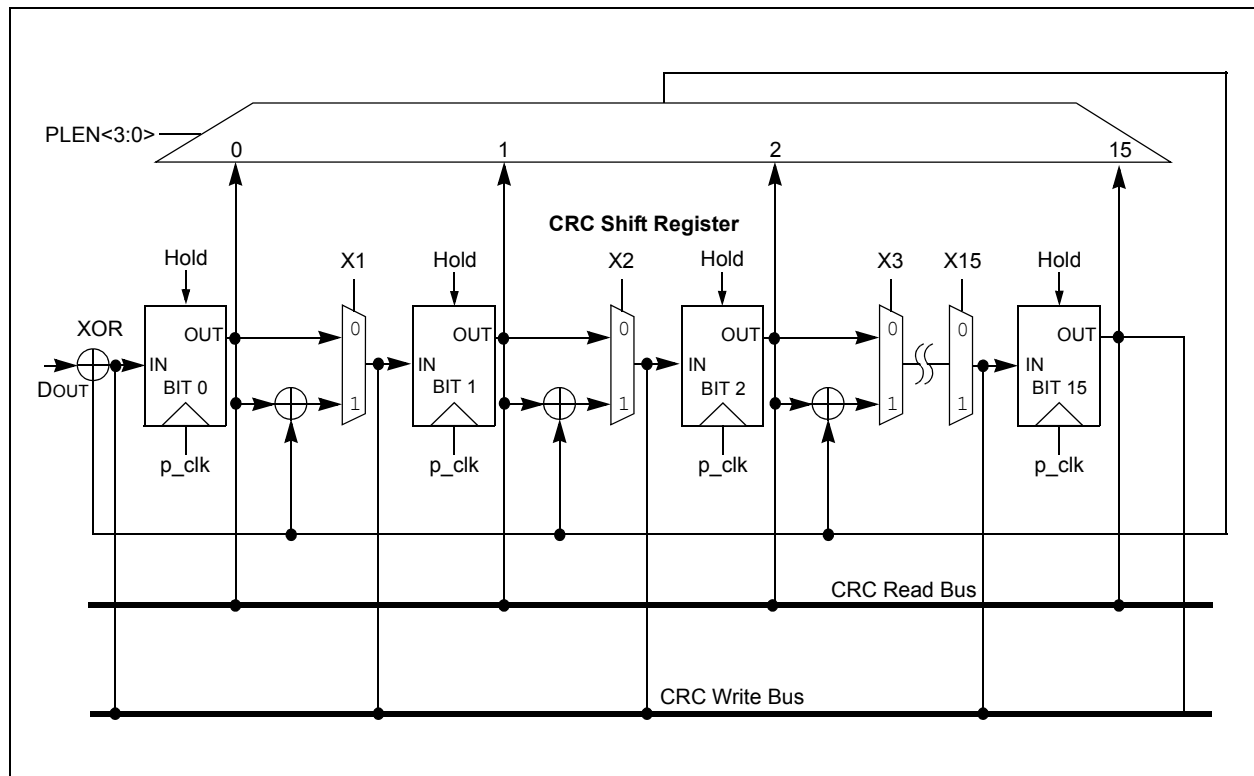
TABLE 26-1: EXAMPLE CRC SETUP

Bit Name	Bit Value
PLEN<3:0>	1111
X<15:1>	000100000010000

For the value of $X<15:1>$, the 12th bit and the 5th bit are set to ‘1’, as required by the CRC equation. The 0th bit required by the CRC equation is always XORed. For a 16-bit polynomial, the 16th bit is also always assumed to be XORed; therefore, the $X<15:1>$ bits do not have the 0th bit or the 16th bit.

The topology of a standard CRC generator is shown in [Figure 26-2](#).

FIGURE 26-1: CRC SHIFTER DETAILS



Most instructions are a single word. Certain double-word instructions are designed to provide all the required information in these 48 bits. In the second word, the 8 MSBs are '0's. If this second word is executed as an instruction (by itself), it executes as a NOP.

The double-word instructions execute in two instruction cycles.

Most single-word instructions are executed in a single instruction cycle, unless a conditional test is true, or the program counter is changed as a result of the instruction. In these cases, the execution takes two instruction cycles with the additional instruction cycle(s) executed as a NOP. Notable exceptions are the BRA

(unconditional/computed branch), indirect CALL/GOTO, all table reads and writes and RETURN/RETFIE instructions, which are single-word instructions but take two or three cycles. Certain instructions that involve skipping over the subsequent instruction require either two or three cycles if the skip is performed, depending on whether the instruction being skipped is a single-word or two-word instruction. Moreover, double-word moves require two cycles.

Note: For more details on the instruction set, refer to the "16-bit MCU and DSC Programmer's Reference Manual" (DS70157).

TABLE 29-1: SYMBOLS USED IN OPCODE DESCRIPTIONS

Field	Description
#text	Means literal defined by "text"
(text)	Means "content of text"
[text]	Means "the location addressed by text"
{ }	Optional field or operation
<n:m>	Register bit field
.b	Byte mode selection
.d	Double-Word mode selection
.S	Shadow register select
.w	Word mode selection (default)
Acc	One of two accumulators {A, B}
AWB	Accumulator write back destination address register $\in \{W13, [W13]+ = 2\}$
bit4	4-bit bit selection field (used in word addressed instructions) $\in \{0...15\}$
C, DC, N, OV, Z	MCU Status bits: Carry, Digit Carry, Negative, Overflow, Sticky Zero
Expr	Absolute address, label or expression (resolved by the linker)
f	File register address $\in \{0x0000...0x1FFF\}$
lit1	1-bit unsigned literal $\in \{0, 1\}$
lit4	4-bit unsigned literal $\in \{0...15\}$
lit5	5-bit unsigned literal $\in \{0...31\}$
lit8	8-bit unsigned literal $\in \{0...255\}$
lit10	10-bit unsigned literal $\in \{0...255\}$ for Byte mode, $\{0:1023\}$ for Word mode
lit14	14-bit unsigned literal $\in \{0...16384\}$
lit16	16-bit unsigned literal $\in \{0...65535\}$
lit23	23-bit unsigned literal $\in \{0...8388608\}$; LSb must be '0'
None	Field does not require an entry, can be blank
OA, OB, SA, SB	DSP Status bits: ACCA Overflow, ACCB Overflow, ACCA Saturate, ACCB Saturate
PC	Program Counter
Slit10	10-bit signed literal $\in \{-512...511\}$
Slit16	16-bit signed literal $\in \{-32768...32767\}$
Slit6	6-bit signed literal $\in \{-16...16\}$
Wb	Base W register $\in \{W0...W15\}$
Wd	Destination W register $\in \{Wd, [Wd], [Wd++], [Wd--], [++Wd], [--Wd]\}$
Wdo	Destination W register $\in \{Wnd, [Wnd], [Wnd++], [Wnd--], [++Wnd], [--Wnd], [Wnd+Wb]\}$
Wm, Wn	Dividend, Divisor working register pair (direct addressing)

FIGURE 31-10: MOTOR CONTROL PWM MODULE FAULT TIMING CHARACTERISTICS

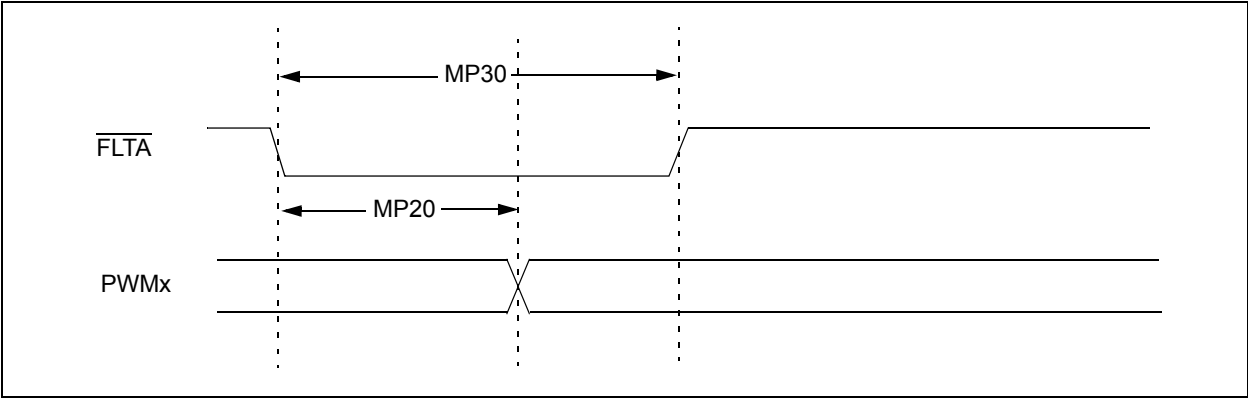


FIGURE 31-11: MOTOR CONTROL PWM MODULE TIMING CHARACTERISTICS

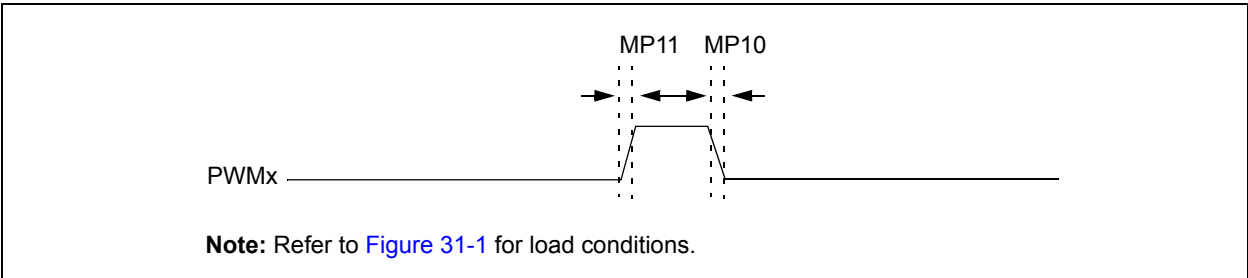


TABLE 31-29: MOTOR CONTROL PWM MODULE TIMING REQUIREMENTS

AC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param No.	Symbol	Characteristic ⁽¹⁾	Min	Typ	Max	Units	Conditions
MP10	TFPWM	PWM Output Fall Time	—	—	—	ns	See parameter DO32
MP11	TRPWM	PWM Output Rise Time	—	—	—	ns	See parameter DO31
MP20	TFD	Fault Input ↓ to PWM I/O Change	—	—	50	ns	—
MP30	TFH	Minimum Pulse Width	50	—	—	ns	—

Note 1: These parameters are characterized but not tested in manufacturing.

FIGURE 31-16: SPIx MASTER MODE (FULL-DUPLEX, CKE = 1, CKP = x, SMP = 1) TIMING CHARACTERISTICS

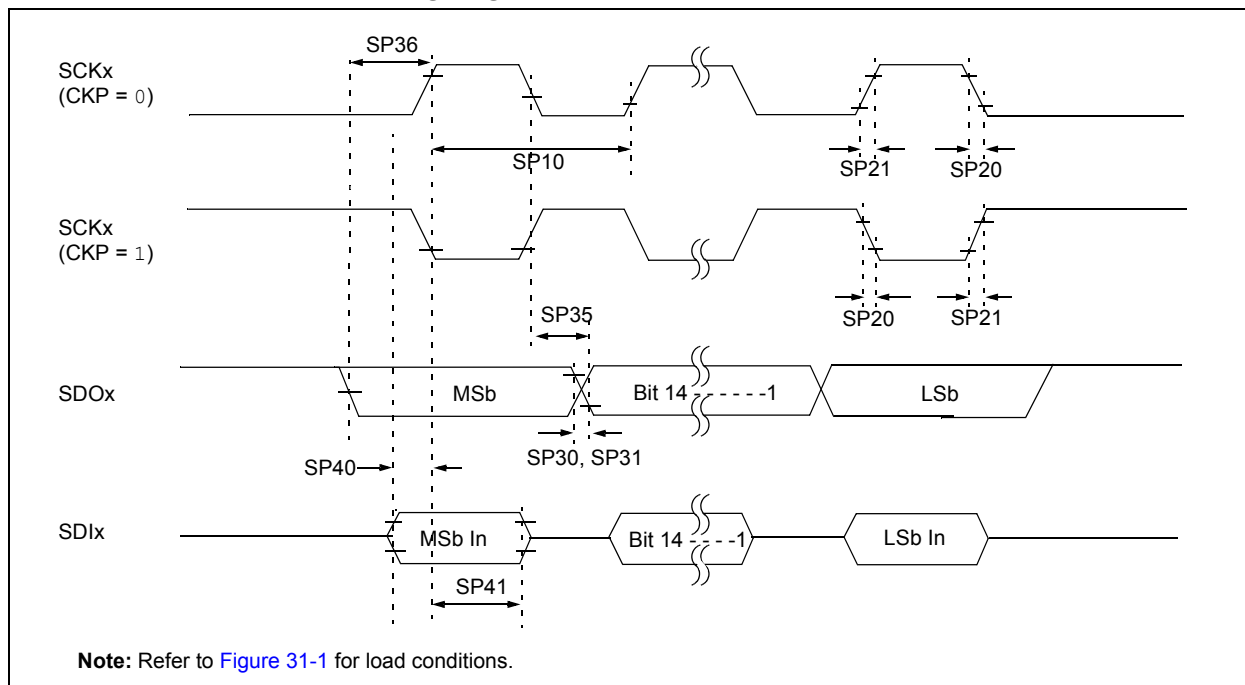


TABLE 31-34: SPIx MASTER MODE (FULL-DUPLEX, CKE = 1, CKP = x, SMP = 1) TIMING REQUIREMENTS

AC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param No.	Symbol	Characteristic ⁽¹⁾	Min	Typ ⁽²⁾	Max	Units	Conditions
SP10	TscP	Maximum SCK Frequency	—	—	9	MHz	See Note 3
SP20	TscF	SCKx Output Fall Time	—	—	—	ns	See parameter DO32 and Note 4
SP21	TscR	SCKx Output Rise Time	—	—	—	ns	See parameter DO31 and Note 4
SP30	TdoF	SDOx Data Output Fall Time	—	—	—	ns	See parameter DO32 and Note 4
SP31	TdoR	SDOx Data Output Rise Time	—	—	—	ns	See parameter DO31 and Note 4
SP35	Tsch2doV, TscL2doV	SDOx Data Output Valid after SCKx Edge	—	6	20	ns	—
SP36	TdoV2sc, TdoV2scL	SDOx Data Output Setup to First SCKx Edge	30	—	—	ns	—
SP40	TdiV2scH, TdiV2scL	Setup Time of SDIx Data Input to SCKx Edge	30	—	—	ns	—
SP41	Tsch2diL, TscL2diL	Hold Time of SDIx Data Input to SCKx Edge	30	—	—	ns	—

Note 1: These parameters are characterized, but are not tested in manufacturing.

Note 2: Data in "Typ" column is at 3.3V, 25°C unless otherwise stated.

Note 3: The minimum clock period for SCKx is 111 ns. The clock generated in Master mode must not violate this specification.

Note 4: Assumes 50 pF load on all SPIx pins.

FIGURE 31-24: I2Cx BUS START/STOP BITS TIMING CHARACTERISTICS (SLAVE MODE)

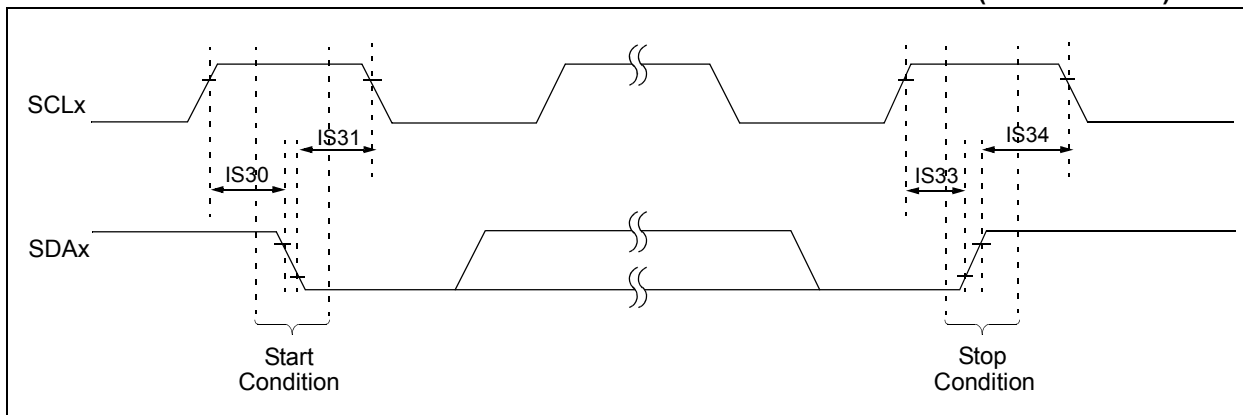


FIGURE 31-25: I2Cx BUS DATA TIMING CHARACTERISTICS (SLAVE MODE)

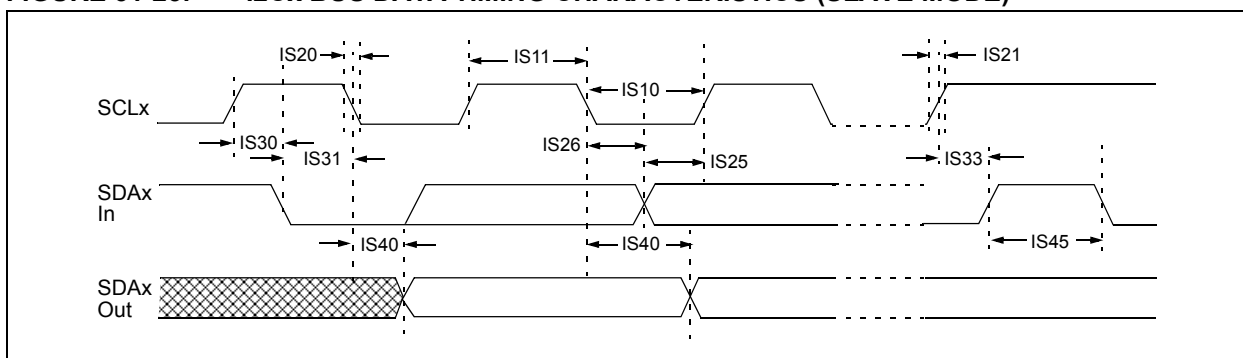


TABLE 32-6: DC CHARACTERISTICS: I/O PIN OUTPUT SPECIFICATIONS

DC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +150^{\circ}\text{C}$ for High Temperature				
Param.	Symbol	Characteristic	Min.	Typ.	Max.	Units	Conditions
DO10	VOL	Output Low Voltage I/O Pins: 2x Sink Driver Pins - RA2, RA7-RA10, RB10, RB11, RB7, RB4, RC3-RC9	—	—	0.4	V	$I_{OL} \leq 1.8 \text{ mA}$, $V_{DD} = 3.3\text{V}$ See Note 1
		Output Low Voltage I/O Pins: 4x Sink Driver Pins - RA0, RA1, RB0-RB3, RB5, RB6, RB8, RB9, RB12-RB15, RC0-RC2	—	—	0.4	V	$I_{OL} \leq 3.6 \text{ mA}$, $V_{DD} = 3.3\text{V}$ See Note 1
		Output Low Voltage I/O Pins: 8x Sink Driver Pins - RA3, RA4	—	—	0.4	V	$I_{OL} \leq 6 \text{ mA}$, $V_{DD} = 3.3\text{V}$ See Note 1
DO20	VOH	Output High Voltage I/O Pins: 2x Source Driver Pins - RA2, RA7-RA10, RB4, RB7, RB10, RB11, RC3-RC9	2.4	—	—	V	$I_{OL} \geq -1.8 \text{ mA}$, $V_{DD} = 3.3\text{V}$ See Note 1
		Output High Voltage I/O Pins: 4x Source Driver Pins - RA0, RA1, RB0-RB3, RB5, RB6, RB8, RB9, RB12-RB15, RC0-RC2	2.4	—	—	V	$I_{OL} \geq -3 \text{ mA}$, $V_{DD} = 3.3\text{V}$ See Note 1
		Output High Voltage I/O Pins: 8x Source Driver Pins - RA4, RA3	2.4	—	—	V	$I_{OL} \geq -6 \text{ mA}$, $V_{DD} = 3.3\text{V}$ See Note 1
DO20A	VOH1	Output High Voltage I/O Pins: 2x Source Driver Pins - RA2, RA7-RA10, RB4, RB7, RB10, RB11, RC3-RC9	1.5	—	—	V	$I_{OH} \geq -1.9 \text{ mA}$, $V_{DD} = 3.3\text{V}$ See Note 1
			2.0	—	—		$I_{OH} \geq -1.85 \text{ mA}$, $V_{DD} = 3.3\text{V}$ See Note 1
			3.0	—	—		$I_{OH} \geq -1.4 \text{ mA}$, $V_{DD} = 3.3\text{V}$ See Note 1
		Output High Voltage 4x Source Driver Pins - RA0, RA1, RB0-RB3, RB5, RB6, RB8, RB9, RB12-RB15, RC0-RC2	1.5	—	—	V	$I_{OH} \geq -3.9 \text{ mA}$, $V_{DD} = 3.3\text{V}$ See Note 1
			2.0	—	—		$I_{OH} \geq -3.7 \text{ mA}$, $V_{DD} = 3.3\text{V}$ See Note 1
			3.0	—	—		$I_{OH} \geq -2 \text{ mA}$, $V_{DD} = 3.3\text{V}$ See Note 1
		Output High Voltage I/O Pins: 8x Source Driver Pins - RA3, RA4	1.5	—	—	V	$I_{OH} \geq -7.5 \text{ mA}$, $V_{DD} = 3.3\text{V}$ See Note 1
			2.0	—	—		$I_{OH} \geq -6.8 \text{ mA}$, $V_{DD} = 3.3\text{V}$ See Note 1
			3.0	—	—		$I_{OH} \geq -3 \text{ mA}$, $V_{DD} = 3.3\text{V}$ See Note 1

Note 1: Parameters are characterized, but not tested.